

COMPONENT-EMBEDDED BOARD FABRICATION METHOD AND
APPARATUS FOR HIGH-PRECISION AND EASY FABRICATION OF
COMPONENT-EMBEDDED BOARD WITH ELECTRONIC COMPONENTS
EMBEDDED IN WIRING BOARD

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An apparatus 1 for fabricating a component-embedded board according to the present invention comprises: a detecting unit 11 for detecting, before the board 21 is covered with an insulating layer 23, the actual position of an electronic component 22 formed on the surface of the board 21; a holding unit 12 for calculating a displacement between the design position of the electronic component 22 and the actual position of the electronic component 22 on the surface of the board 21, and for holding the displacement as displacement data; and a correcting unit 13 for correcting, based on the displacement data, design data to be used for processing the board 21 after the board 21 is covered with the insulating layer 23.

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